

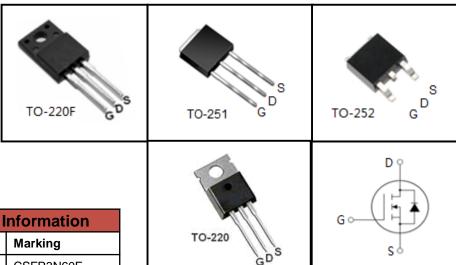
600V N-Channel MOSFET

FEATURES

- Fast switching
- Integrate fast recovery diode
- Fast switching speed
- 100% avalanche tested
- Improved dv/dt capability

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Motor Controls
- Power Factor Correction (PFC)



Device Marking and Package Information					
Device	Package	Marking			
CSFR3N60F	TO-220F	CSFR3N60F			
CSFR3N60P	TO-220	CSFR3N60P			
CSFR3N60U	TO-251	CSFR3N60U			
CSFR3N60D	TO-252	CSFR3N60D			

Absolute Maximum Ratings T _C = 25°C, unless otherwise noted								
Parameter	Symbol		l lesit					
raiametei		TO-220F	TO-220	TO-251	TO-252	Unit		
Drain-Source Voltage (V _{GS} = 0V)	V _{DSS}	600			٧			
Continuous Drain Current	I _D	3			Α			
Pulsed Drain Current (note1)	I _{DM}	12				Α		
Gate-Source Voltage	V _{GSS}	±30			V			
Single Pulse Avalanche Energy (note2)	E _{AS}	45			mJ			
Avalanche Current (note1)	I _{AS}	3			Α			
Repetitive Avalanche Energy (note1)	E _{AR}	27			mJ			
Power Dissipation (T _C = 25°C)	P _D	30		45		W		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150			°C			

Thermal Resistance						
Baranatar	Symbol	Value				11
Parameter		TO-220F	TO-251	TO-252	TO-220	Unit
Thermal Resistance, Junction-to-Case	R _{thJC}	4.1		2.8		12/\\\
Thermal Resistance, Junction-to-Ambient	R _{thJA}	62.5		60		K/W

Specifications $T_J = 25^{\circ}$ C, unless otherwise noted									
Parameter		Took Conditions	Value						
	Symbol	Test Conditions	Min.	Тур.	Max.	Unit			
Static									
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_{D} = 250\mu A$	600			V			
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 600V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μΑ			
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30V$			±100	nA			
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = = 250μA	3.0		4.0	V			
Drain-Source On-Resistance (Note3)	R _{DS(on)}	$V_{GS} = 10V, I_D = 1.5A$		2.8	3.4	Ω			
Dynamic									
Input Capacitance	C _{iss}	V 0V		400		pF			
Output Capacitance	C _{oss}	$V_{GS} = 0V,$ $V_{DS} = 25V,$		43					
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		5					
Total Gate Charge	Q_g			13.5		nC			
Gate-Source Charge	Q_{gs}	$V_{DD} = 480V, I_{D} = 3.0A,$ $V_{GS} = 10V$		2					
Gate-Drain Charge	Q_{gd}	1 63 1 1 1		6					
Turn-on Delay Time	t _{d(on)}			34		ns			
Turn-on Rise Time	t _r	$V_{DD} = 300V, I_{D} = 3.0A,$		8					
Turn-off Delay Time	t _{d(off)}	$R_G = 25 \Omega$		79					
Turn-off Fall Time	t _f			28					
Drain-Source Body Diode Character	istics								
Continuous Body Diode Current	I _S				3	A			
Pulsed Diode Forward Current	I _{SM}	T _C = 25 °C			12				
Body Diode Voltage	V _{SD}	$T_J = 25^{\circ}\text{C}, I_{SD} = 1.5\text{A}, V_{GS} = 0\text{V}$			1.4	٧			
Reverse Recovery Time	t _{rr}	$V_{GS} = 0V, I_{S} = 3.0A,$		55		ns			
Reverse Recovery Charge	Q _{rr}	di _F /dt =100A /μs		0.055		μC			

Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L=10mH, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}C$
- 3. Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 1%



Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

Figure 1. Output Characteristics (T_J = 25°C)

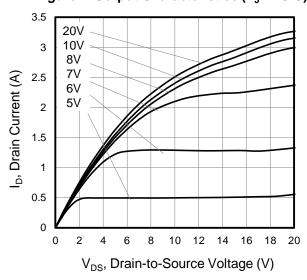


Figure 2. Body Diode Forward Voltage

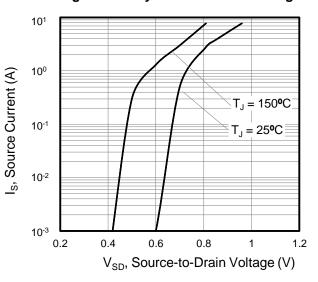


Figure 3. Drain Current vs. Temperature

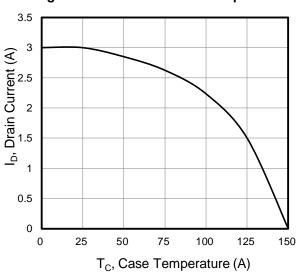


Figure 4. Power Dissipation vs. Temperature

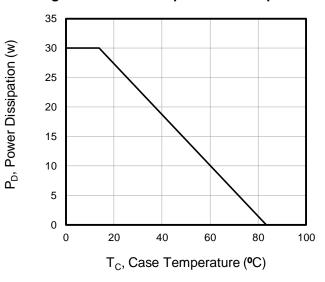


Figure 5. Transfer Characteristics

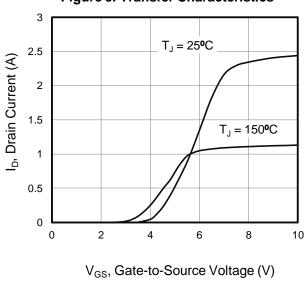
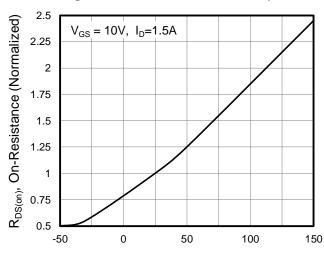
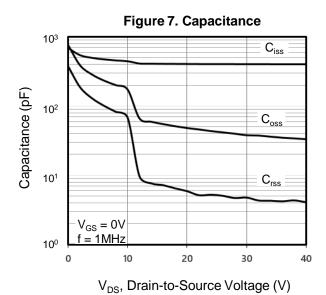


Figure 6. On-Resistance vs. Temperature





Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted



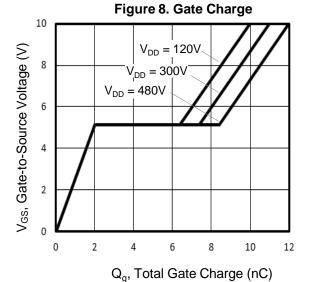


Figure 9. Transient Thermal Impedance TO-220F

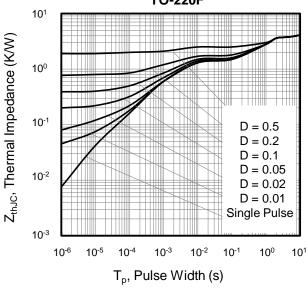


Figure 10. Transient Thermal Impedance TO-220, TO-251, TO-252

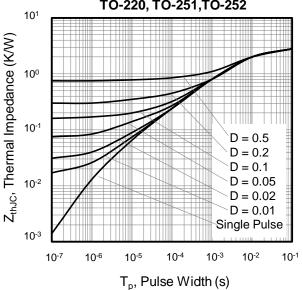




Figure A: Gate Charge Test Circuit and Waveform

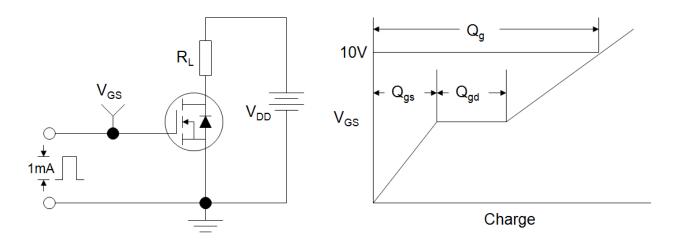


Figure B: Resistive Switching Test Circuit and Waveform

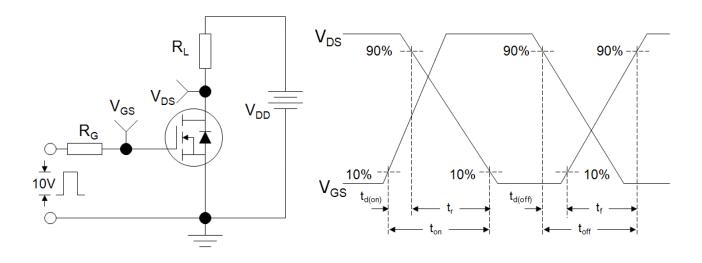
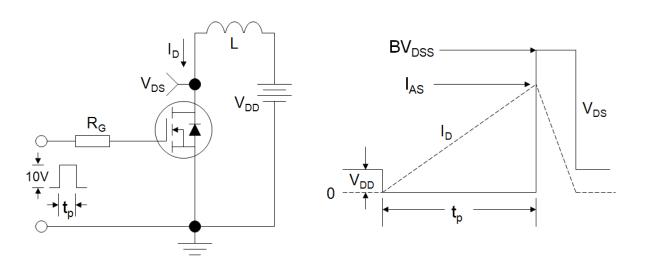
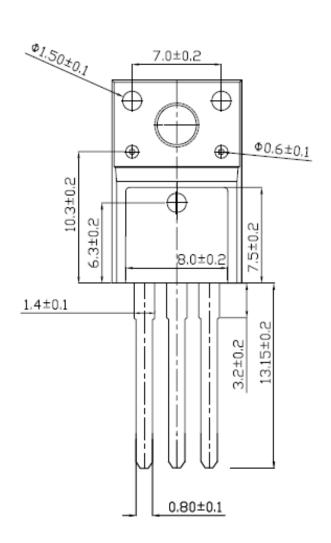


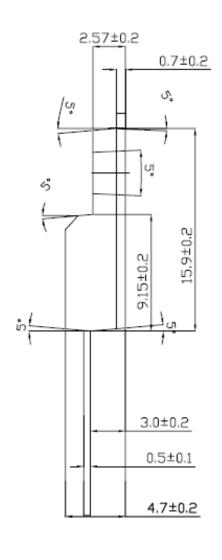
Figure C: Unclamped Inductive Switching Test Circuit and Waveform





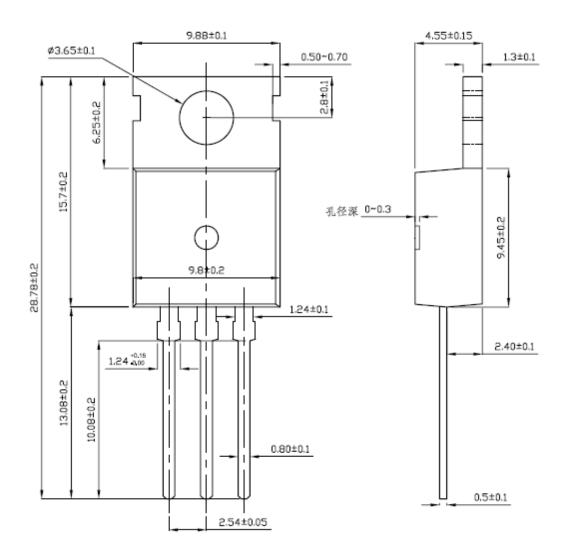
TO-220F





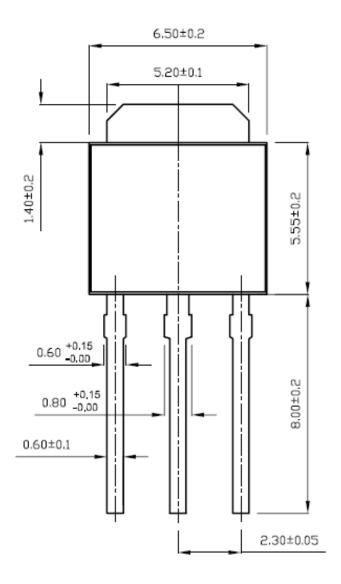


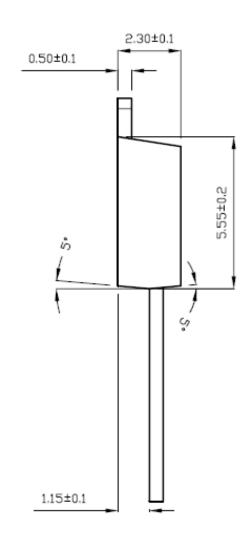
TO-220





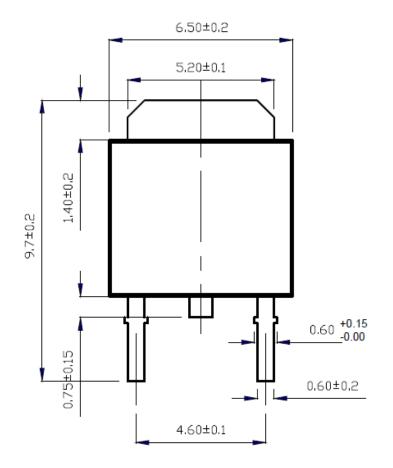
TO-251

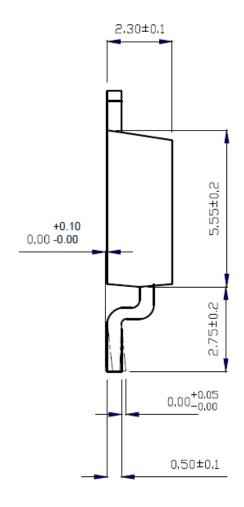






TO-252





CSFR3N60F,CSFR3N60P CSFR3N60U,CSFR3N60D

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